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APPLICANT(S)
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GROUP ART UNIT
Not yet assigned

U.S. PATENT DOCUMENTS

[illegible]

FOREIGN PATENT DOCUMENTS

	DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUB CLASS	TRANSLATION	
						YES	NO
/D.M./	05-229820	7/9/1993	Japan				X

OTHER DOCUMENTS

/D.M./	<i>Joining of melt-textured YBCO: a direct contact method</i> , Chen et al., <u>Institute of Physics Publishing Superconductor Science and Technology</u> , Vol. 15, pp. 672-674, April 2002.	
/D.M./	<i>Processing, microstructure and characterization of artificial joins in top seeded melt grown Y-Ba-Cu-O</i> , Cardwell et al., <u>Institute of Physics Publishing Superconductor Science and Technology</u> , Vol. 15, pp 639-647, April 2002.	
/D.M./	<i>Project of RE123 Bulk Superconductors Fabrication in a Microgravity Environment</i> , Sakai et al., <u>Cryogenics</u> , Vol. 34, pp. 561-568, June 1999.	
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